Shan-Yuan Teng



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research: enabling haptic experiences anywhere, anytime

My research aims to advance a new generation of **haptic devices** (e.g., those that can create the sense of touch, forces, etc.) that exhibit properties that we become used to expect from our mobile phones & wearables, **such as extreme mobility, availability anytime, etc**. To advance haptics into this new territory and grant these novel properties, I engineer custom-made interactive devices that, for instance: allow to feel touch in mixed reality without encumbering our fingerpads, or even haptic devices with virtually infinite battery life. I have published this work as **16 papers** (**7 as the leading author**) at **top Human-Computer Interaction (HCI) conferences** including **ACM CHI & UIST**, with **2 Best Paper Awards** and **5 Honorable Mention Awards**.

education

present PhD candidate (Computer Science) at University of Chicago, USA advisor: Prof. Pedro Lopes (University of Chicago)

2018 **MS (Degree Computer Science) at National Taiwan University, Taiwan** advisor: Prof. Bing-Yu 'Robin' Chen (National Taiwan University)

2016 BS (Degree Electrical Engineering) at National Taiwan University, Taiwan

fellowships

Eckhardt Graduate Scholarship (USD 40k total, 2019-2024), University of Chicago William Rainey Harper Dissertation Fellowship (2023-2024), University of Chicago

academic awards

Best Paper Awards: UIST 2021, UIST 2020 Best Demo Awards: UIST 2021 (x2)

Honorable Mention Awards: UIST 2024, UIST 2022, CHI 2021, CHI 2020, UIST 2019

publications (ACM CHI, UIST* & Science Advances)

* ACM CHI and UIST are the premier venues for technical Human-Computer Interaction (HCI) publications, fully peer-reviewed and at an acceptance rate of 20-25%. These are regarded as top-tier in the field, even when considering HCI journals, and Computer Science is a conference-focused discipline.

[17] Haptic permeability: adding holes to tactile devices improves dexterity. Shan-Yuan Teng, Aryan Gupta, Pedro Lopes. CHI 2024 Paper.

[16] Can a smartwatch move your fingers? Compact and practical electrical muscle stimulation in a smartwatch.

Akifumi Takahashi, Yudai Tanaka, Archit Tamhane, Alan Shen, **Shan-Yuan Teng**, Pedro Lopes. *UIST 2024 Paper*. **WIST Honorable Mention Award**

[15] ThermalRouter: enabling users to design thermally-sound devices.
Alex Mazursky, Borui Li, Shan-Yuan Teng, Daria Shifrina, Joyce E. Passananti, Svitlana Midianko, Pedro Lopes.
UIST 2023 Paper.

[14] Prolonging VR haptic experiences by harvesting kinetic energy from the user. Shan-Yuan Teng, K. D. Wu, Jacqueline Chen, Pedro Lopes.

UIST 2022 Paper. W UIST Honorable Mention Award

[13] Touch&Fold: a foldable haptic actuator for rendering touch in mixed reality. Shan-Yuan Teng, Pengyu Li, Romain Nith, Joshua Fonseca, Pedro Lopes. CHI 2021 Paper. CHI Honorable Mention Award

[12] Altering perceived softness of real rigid objects by restricting fingerpad deformation. Yujie Tao, **Shan-Yuan Teng**, Pedro Lopes.

UIST 2021 Paper. The UIST Best Paper Award UIST Best Demo Award (jury's award)

[11] DextrEMS: increasing dexterity in electrical muscle stimulation by combining it with brakes.

Romain Nith, **Shan-Yuan Teng**, Pengyu Li, Yujie Tao, Pedro Lopes.

UIST 2021 Paper. Z UIST Best Demo Award (people's choice)

[10] MagnetIO: passive yet interactive soft haptic patches anywhere.

Alex Mazursky, **Shan-Yuan Teng**, Romain Nith, Pedro Lopes.

CHI 2021 Paper.

[9] Stereo-smell via electrical trigeminal stimulation.

Jas Brooks, **Shan-Yuan Teng**, Jingxuan Wen, Romain Nith, Jun Nishida, Pedro Lopes.

CHI 2021 Paper.

[8] Elevate: a walkable pin-array.

Seungwoo Je, Hyunseung Lim, Kongpyung Moon, **Shan-Yuan Teng**, Jas Brooks, Pedro Lopes, Andrea Bianchi.

CHI 2021 Paper.

[7] A stretchable and strain-unperturbed pressure sensor for motion-interference-free tactile monitoring

on skins.

Qi Su, Q. Zou, Yang Li, Yuzhen Chen, **Shan-Yuan Teng**, Jane Tunde Kelleher, Romain Nith, Ping Cheng, Nan Li,

Wei Liu, Shilei Dai, Youdi Liu, Alex Mazursky, Jie Xu, Lihua Jin, Pedro Lopes, Sihong Wang.

Science Advances, 2021.

[6] HandMorph: a passive exoskeleton that miniaturizes grasp.

Jun Nishida, Soichiro Matsuda, Hiroshi Matsui, **Shan-Yuan Teng**, Ziwei Liu, Kenji Suzuki, Pedro Lopes.

UIST 2020 Paper. X UIST Best Paper Award

[5] Wearable microphone jamming.

Shan-Yuan Teng*, Yuxin Chen*, Huiying Li*, Steven Nagels, Zhijing Li, Pedro Lopes, Ben Y. Zhao, Haitao Zheng.

(*equal contribution)

CHI 2020 Paper. W CHI Honorable Mention Award

[4] TilePoP: tile-type pop-up prop for virtual reality.

Shan-Yuan Teng, Cheng-Lung Lin, Chi-huan Chiang, Tzu-Sheng Kuo, Liwei Chan, Da-Yuan Huang, Bing-Yu Chen.

UIST 2019 Paper. W UIST Honorable Mention Award W UIST Honorable Mention for Best Talk

[3] Aarnio: passive kinesthetic force output for foreground interactions on an interactive chair. Shan-Yuan Teng, Da-Yuan Huang, Chi Wang, Teddy Seyed, Jun Gong, Xing-Dong Yang, Bing-Yu Chen.

Shan-Yuan Teng, Da-Yuan Huang, Chi Wang, Teddy Seyed, Jun Gong, Xing-Dong Yang, Bing-Yu Che CHI 2019 Paper.

[2] PuPoP: pop-up prop on palm for virtual reality.

Shan-Yuan Teng, Tzu-Sheng Kuo, Chi Wang, Chi-huan Chiang, Da-Yuan Huang, Liwei Chan, Bing-Yu Chen. *UIST 2018 Paper*.

0131 2010 Fapei.

[1] Outside-In: visualizing out-of-sight regions-of-interest in a 360 video using spatial picture-in-picture previews.

. Yung-Ta Lin, Yi-Chi Liao, **Shan-Yuan Teng**, Yi-Ju Chung, Liwei Chan, Bing-Yu Chen.

UIST 2017 Paper.

patent

[1] Wearable microphone jammer US Patent (US20230131816A1)

professional services

Program Committee: ACM UIST 2024, SUI 2024/2023, ISS 2024 Editorial Board,

ISWC 2022, Augmented Humans 2024/2023,

Demo Chair: ACM Augmented Humans 2021

Video Preview Chair: ACM UIST 2024

Paper Session Chair: ACM UIST 2024, CHI 2023/2022

Paper Reviewer: ACM CHI, UIST, IMWUT, TEI, DIS, IMX, SIGGRAPH (Technical Paper)

IEEE VR, IEEE Haptics, IEEE ISMAR, IEEE World Haptics
International Journal of Human-Computer Studies

Student Volunteer: ACM UIST 2022/2020, IEEE Haptics 2022

demonstrations (ACM SIGGRAPH, IEEE Haptics Symposium & World Haptics)

[4] Demonstrating haptic permeability: adding holes to tactile devices improves dexterity. **Shan-Yuan Teng**, Aryan Gupta, Pedro Lopes. *IEEE Haptics Symposium 2024*.

[3] Demonstrating touch&fold: a foldable haptic actuator for rendering touch in mixed reality. **Shan-Yuan Teng**, Pengyu Li, Romain Nith, Joshua Fonseca, Pedro Lopes. *SIGGRAPH 2021 Emerging Technologies, IEEE World Haptics 2023.*

[2] Demonstrating magnetIO: passive yet interactive soft haptic patches anywhere. Alex Mazursky, Shan-Yuan Teng, Romain Nith, Pedro Lopes. SIGGRAPH 2021 Emerging Technologies.

[1] Stylus assistant: designing dynamic constraints for facilitating stylus inputs on portable displays. Long-Fei Lin, **Shan-Yuan Teng**, Rong-Hao Liang, Bing-Yu Chen. SIGGRAPH ASIA 2016 Emerging Technologies.

workshops

[4] Enabling haptic experiences anywhere, anytime.

Shan-Yuan Teng, Pedro Lopes.

IEEE Haptics Symposium 2024: Cross-cutting Challenges

[3] Experience haptics seamlessly across virtual and real worlds.

Shan-Yuan Teng, Pedro Lopes.

IEEE VR 2024: 1st Workshop on Seamless Reality.

[2] Enabling haptic experiences anywhere, anytime.

Shan-Yuan Teng.

SIGGRAPH 2022 Frontiers Workshop.

[1] Building miniature and standalone haptic wearables for integrating into the real world. Romain Nith, **Shan-Yuan Teng**, Pedro Lopes. *CHI 2022: Sustainable Haptic Design*.

magazine article

[1] XR needs "mixed feelings": engineering haptic devices that work in both virtual and physical realities.

Shan-Yuan Teng, Pedro Lopes.

ACM XRDS 2022: Crossroads Magazine Article.

student research projects

[2] Way out: a multi-layer panorama mobile game using around-body interactions. Shan-Yuan Teng, Mu-Hsuan Chen, Yung-Ta Lin. CHI 2017 Student Game Competition.

[1] Playing air guitar using electrical muscle stimulation.

Shan-Yuan Teng, Yung-Ta Lin, Yi-Chi Liao.

UIST 2016 Student Innovation Contest.

invited talks

- [7] University of California, Los Angeles (2024) hosted by Prof. Yang Zhang.
- [6] Cornell Tech (2024) hosted by Prof. Thijs Roumen.
- [5] University of Toronto (2024) hosted by Bryan Wang.
- [4] Stanford University (2023) hosted by Yujie Tao & Matthew Jörke.
- [3] Eindhoven University of Technology (2023) hosted by Prof. Rong-Hao Liang.
- [2] National Taiwan University (2022) hosted by Prof. Lung-Pan Cheng.
- [1] Simon Fraser University (2022) hosted by Prof. Xing-Dong Yang.

teaching experience

- [8] Mentor "After School Matters: STEM Laboratory Research Internship" High school internship program hosted by the University of Chicago, 2024.
- [7] Teaching assistant "Make Your Own Wearables from Scratch" Workshop for Chicago Public Schools hosted by the University of Chicago, 2023.
- [6] Guest lecture in Human-Computer Interaction and Neuroscience (CMSC 33231-1) Winter 2022 graduate course at the University of Chicago.
- [5] Guest lecture in "Human-Centered Computing Research" (CSE 60427) Fall 2022 graduate course at University of Notre Dame.
- [4] Teaching assistant "Inventing, Engineering and Understanding Interactive Devices" (CMSC 23220) Spring 2022 course at the University of Chicago.
- [3] Teaching assistant "Engineering Interactive Electronics onto Printed Circuit Boards" (CMSC 23230/CMSC 33230)
 Spring 2021 course at the University of Chicago.
- [2] Teaching assistant "Emerging Interface Technologies" (CMSC 33240/CMSC 23240) Winter 2020 course at the University of Chicago.
- [1] Teaching assistant "Introduction to Human-Computer Interaction" (CMSC 20300) Fall 2019 course at the University of Chicago.